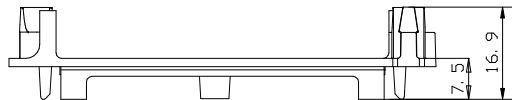
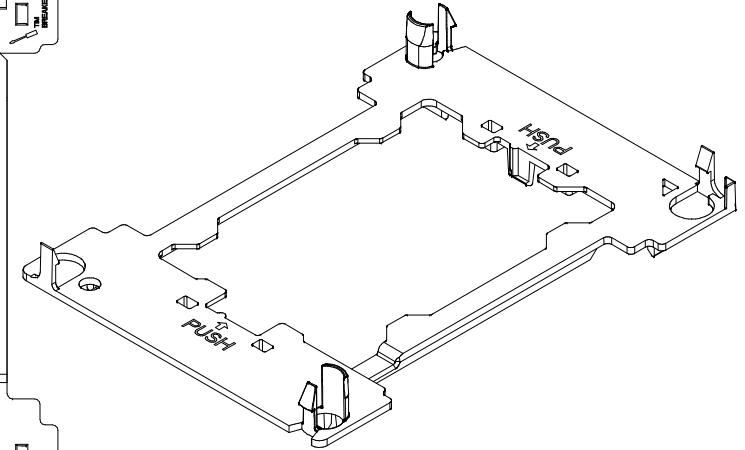
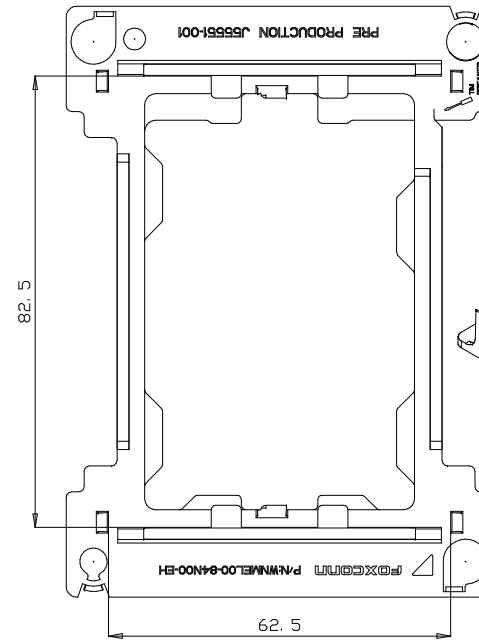
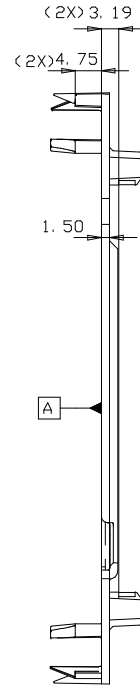
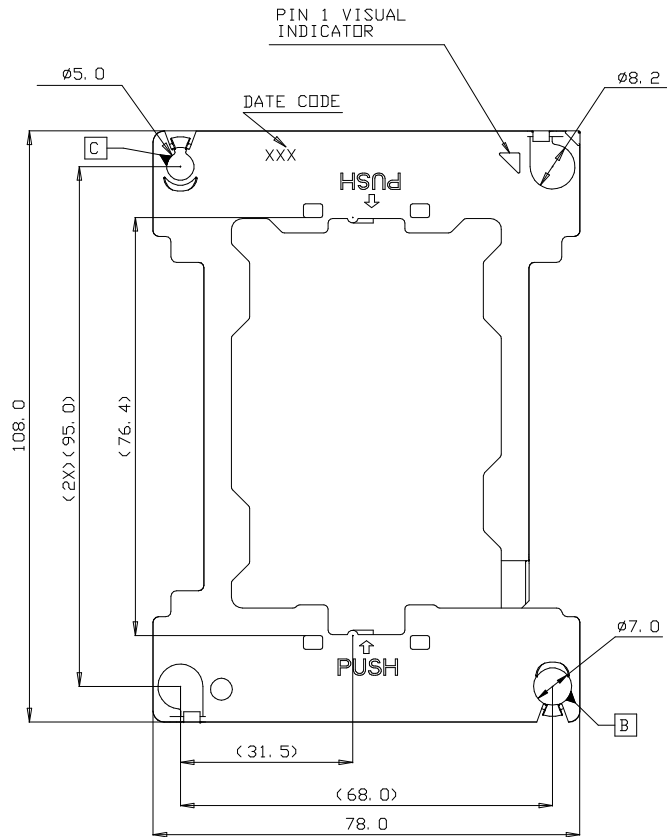


REV.	ECN. NO.	APPD.
A	BC-17-0020154	NICK LIN

NOTES:

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
3. MATERIAL: PC-ABS, BLACK.
4. HARMFUL MATERIAL CONTROL PLEASE FOLLOW DOC. NO. "EPI12".
5. PLEASE CONTACT FOXCONN SALES REPRESENTATIVE TO VERIFY PRODUCT DETAIL AND AVAILABILITY.
6. THE CONCENTRATIONS OF Br AND Cl CAN SATISFY THE REQUIREMENT OF HALOGEN-FREE IN DOCUMENT "EPI12".



X. $\pm$ 0.5	X. $^{\circ}$ $\pm$ 1 $^{\circ}$	UNITS mm	NAME (INTENDED USE)	<b>FOXCONN</b> FOXCONN INTERCONNECT TECHNOLOGY LIMITED.
.X $\pm$ 0.5	.X $^{\circ}$ $\pm$	MAT'L	LGA3647 SKX BOLSTER	
.XX $\pm$ 0.25	.XX $^{\circ}$ $\pm$	FINISH 	PART NO. (INTENDED USE)	CLASS: <input type="checkbox"/> CONFIDENTIAL <input type="checkbox"/> SECRET <input checked="" type="checkbox"/> GENERAL
.XXX $\pm$	.XXX $^{\circ}$ $\pm$		WNMEL00-84N00-EH	TITLE: CUSTOMER DRAWING FOR SKX FPGA NRW-NF CPU CARRIER
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			CHKD: Dickie Huang Mac Peng	351-0000-1445
			DR: Daryl Tan 7/14/17	SCALE SHEET REV. 1:1 1/1 A